Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	31	257/778.ccls. and (silicon with interposer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:37
L2	8	L1 and (@ad<"19980831")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:38
L3	15401	(chip or die) and ((silicon and (via or pth or hole)) with (substrate or board or interposer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:16
L4	9729	(chip or die) and ((silicon and (via or pth or hole)) with (substrate or board or interposer))	USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:15
L5	4939	L4 and (@ad<"19980831")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:16
L6	2024	L5 and ((form or make or laser or punch or cut or etch) with (via or pth or hole))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:17
L7	371	L6 and flip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:19
L8	29	L7 and interposer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:28
L9	1	("6829149").PN.	USPAT	OR	OFF	2005/02/28 11:32
L10	1	("6281042").PN.	USPAT	OR	OFF	2005/02/28 11:32
L11	27	257/777.ccls. and (silicon with interposer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:37

L12	5	L11 and (@ad<"19980831")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2005/02/28 11:38